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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Obsolete
Core Processor	Z8S180
Number of Cores/Bus Width	1 Core, 8-Bit
Speed	20MHz
Co-Processors/DSP	-
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	64-DIP (0.750", 19.05mm)
Supplier Device Package	64-DIP
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8s18020psc

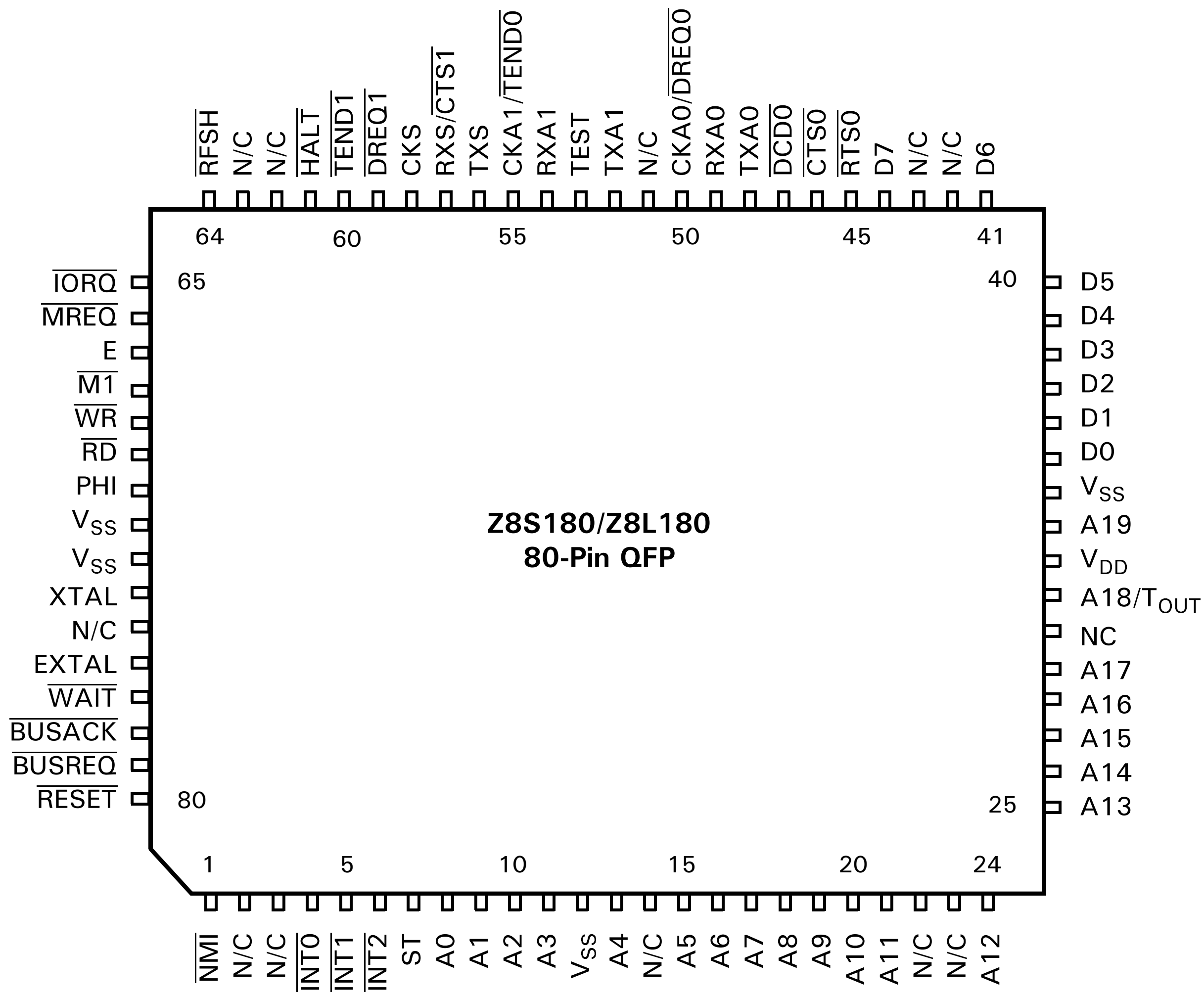


Figure 4. Z8S180/Z8L180 80-Pin QFP Pin Configuration

Table 1. Z8S180/Z8L180 Pin Identification

Pin Number and Package Type			Default Function	Secondary Function	Control
QFP	PLCC	DIP			
1	9	8	$\overline{NMI}$		
2			NC		
3			NC		
4	10	9	$\overline{INT0}$		
5	11	10	$\overline{INT1}$		
6	12	11	$\overline{INT2}$		
7	13	12	ST		
8	14	13	A0		
9	15	14	A1		
10	16	15	A2		
11	17	16	A3		
12	18		V_{SS}		

Table 1. Z8S180/Z8L180 Pin Identification (Continued)

Pin Number and Package Type			Default Function	Secondary Function	Control
QFP	PLCC	DIP			
53	52		TEST		
54	53	49	RXA1		
55	54	50	CKA1	$\overline{\text{TEND0}}$	Bit 4 of CNTLA1
56	55	51	TXS		
57	56	52	RXS	$\overline{\text{CTS1}}$	Bit 2 of STAT1
58	57	53	CKS		
59	58	54	$\overline{\text{DREQ1}}$		
60	59	55	$\overline{\text{TEND1}}$		
61	60	56	$\overline{\text{HALT}}$		
62			NC		
63			NC		
64	61	57	$\overline{\text{RFSH}}$		
65	62	58	$\overline{\text{IORQ}}$		
66	63	59	$\overline{\text{MREQ}}$		
67	64	60	E		
68	65	61	$\overline{\text{M1}}$		
69	66	62	$\overline{\text{WR}}$		
70	67	63	$\overline{\text{RD}}$		
71	68	64	PHI		
72	1	1	V_{SS}		
73	2		V_{SS}		
74	3	2	XTAL		
75			NC		
76	4	3	EXTAL		
77	5	4	$\overline{\text{WAIT}}$		
78	6	5	$\overline{\text{BUSACK}}$		
79	7	6	$\overline{\text{BUSREQ}}$		
80	8	7	$\overline{\text{RESET}}$		

PIN IDENTIFICATION (Continued)

Table 2. Pin Status During RESET, BUSACK, and SLEEP Modes (Continued)

Pin Number and Package Type					Pin Status		
QFP	PLCC	DIP	Default Function	Secondary Function	RESET	BUSACK	SLEEP
76	4	3	EXTAL		IN	IN	IN
77	5	4	$\overline{\text{WAIT}}$		IN	IN	IN
78	6	5	$\overline{\text{BUSACK}}$		High	OUT	OUT
79	7	6	$\overline{\text{BUSREQ}}$		IN	IN	IN
80	8	7	$\overline{\text{RESET}}$		IN	IN	IN

PIN DESCRIPTIONS (Continued)

ways recognized at the end of an instruction, regardless of the state of the interrupt-enable flip-flops. This signal forces CPU execution to continue at location 0066H.

PHI. System Clock (Output). The output is used as a reference clock for the MPU and the external system. The frequency of this output may be one-half, equal to, or twice the crystal or input clock frequency.

$\overline{RD}$. Read (Output, active Low, 3-state). $\overline{RD}$ indicates that the CPU wants to read data from either memory or an I/O device. The addressed I/O or memory device should use this signal to gate data onto the CPU data bus.

$\overline{RFSH}$. Refresh (Output, active Low). Together with $\overline{MREQ}$, $\overline{RFSH}$ indicates that the current CPU machine cycle and the contents of the address bus should be used for refresh of dynamic memories. The low-order 8 bits of the address bus (A7–A0) contain the refresh address. *This signal is analogous to the $\overline{REF}$ signal of the Z64180.*

$\overline{RTS0}$. Request to Send 0 (Output, active Low); a programmable MODEM control signal for ASCI channel 0.

RXA0, RXA1. Receive Data 0 and 1 (Input). These signals are the receive data for the ASCI channels.

RXS. Clocked Serial Receive Data (Input). This line is the receive data for the CSI/O channel. RXS is multiplexed with the $\overline{CTS1}$ signal for ASCI channel 1.

ST. Status (Output). This signal is used with the $\overline{M1}$ and $\overline{HALT}$ output to decode the status of the CPU machine cycle. See Table 3.

Table 3. Status Summary

ST	$\overline{HALT}$	$\overline{M1}$	Operation
0	1	0	CPU Operation (1st Opcode Fetch)
1	1	0	CPU Operation (2nd Opcode and 3rd Opcode Fetch)
1	1	1	CPU Operation (MC Except Opcode Fetch)
0	X	1	DMA Operation
0	0	0	HALT Mode
1	0	1	SLEEP Mode (Including SYSTEM STOP Mode)

Notes:
X = Do not care.
MC = Machine Cycle.

$\overline{TEND0}$, $\overline{TEND1}$. Transfer End 0 and 1 (Outputs, active Low). This output is asserted active during the most recent WRITE cycle of a DMA operation. It is used to indicate the end of the block transfer. $\overline{TEND0}$ is multiplexed with CKA1.

TEST. Test (Output, not in DIP version). This pin is for test and should be left open.

T_{OUT}. Timer Out (Output). T_{OUT} is the output from PRT channel 1. This line is multiplexed with A18 of the address bus.

TXA0, TXA1. Transmit Data 0 and 1 (Outputs). These signals are the transmitted data from the ASCI channels. Transmitted data changes are with respect to the falling edge of the transmit clock.

TXS. Clocked Serial Transmit Data (Output). This line is the transmitted data from the CSI/O channel.

$\overline{WAIT}$. Wait (Input, active Low). $\overline{WAIT}$ indicates to the MPU that the addressed memory or I/O devices are not ready for data transfer. This input is sampled on the falling edge of T2 (and subsequent WAIT states). If the input is sampled Low, then the additional WAIT states are inserted until the $\overline{WAIT}$ input is sampled High, at which time execution continues.

$\overline{WR}$. WRITE (Output, active Low, 3-state). $\overline{WR}$ indicates that the CPU data bus holds valid data to be stored at the addressed I/O or memory location.

XTAL. Crystal Oscillator Connection (Input). This pin should be left open if an external clock is used instead of a crystal. The oscillator input is not a TTL level (see DC Characteristics).

Several pins are used for different conditions, depending on the circumstance.

STANDARD TEST CONDITIONS

The following standard test conditions apply to DC Characteristics, unless otherwise noted. All voltages are referenced to V_{SS} (0V). Positive current flows into the referenced pin.

All AC parameters assume a load capacitance of 100 pF. Add a 10-ns delay for each 50-pF increase in load up to a maximum of 200 pF for the data bus and 100 pF for the address and control lines. AC timing measurements are referenced to V_{OL} MAX or V_{OL} MIN as indicated in Figures 20 through 30 (except for CLOCK, which is referenced to the 10% and 90% points). Ordering Information lists temperature ranges and product numbers. Find package drawings in Package Information.

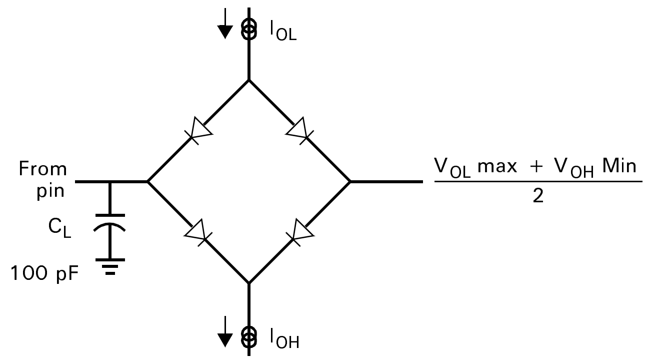


Figure 19. AC Parameter Test Circuit

ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{DD}	–0.3 ~ +7.0	V
Input Voltage	V_{IN}	–0.3 ~ V_{cc} +0.3	V
Operating Temperature	T_{OPR}	0 ~ 70	°C
Extended Temperature	T_{EXT}	–40 ~ 85	°C
Storage Temperature	T_{STG}	–55 ~ +150	°C

Note: Permanent damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability.

DC CHARACTERISTICS—Z8S180

Table 6. Z8S180 DC Characteristics
V_{DD} = 5V ±10%; V_{SS} = 0V

Symbol	Item	Condition	Min	Typ	Max	Unit
V_{IH1}	Input H Voltage $\overline{RESET}$, EXTAL, $\overline{NMI}$		V_{DD} –0.6	—	V_{DD} +0.3	V
V_{IH2}	Input H Voltage Except $\overline{RESET}$, EXTAL, $\overline{NMI}$		2.0	—	V_{DD} +0.3	V
V_{IH3}	Input H Voltage CKS, CKA0, CKA1		2.4	—	V_{DD} +0.3	V
V_{IL1}	Input L Voltage RESET, EXTAL, NMI		–0.3	—	0.6	V
V_{IL2}	Input L Voltage Except RESET, EXTAL, NMI		–0.3	—	0.8	V
V_{OH}	Outputs H Voltage All outputs	I_{OH} = –200 μA	2.4	—	—	V
		I_{OH} = –20 μA	V_{DD} –1.2	—	—	
V_{OL}	Outputs L Voltage All outputs	I_{OL} = 2.2 mA	—	—	0.45	V
I_{IL}	Input Leakage Current All Inputs Except XTAL, EXTAL	V_{IN} = 0.5 ~ V_{DD} –0.5	—	—	1.0	μA
I_{TL}	Three State Leakage Current	V_{IN} = 0.5 ~ V_{DD} –0.5	—	—	1.0	μA
I_{DD}[1]	Power Dissipation (Normal Operation)	F = 10 MHz	—	25	60	mA
		20		30	50	
		33		60	100	
	Power Dissipation (SYSTEM STOP mode)	F = 10 MHz	—	2	5	
		20		3	6	
		33		5	9	
C_P	Pin Capacitance	V_{IN} = 0_V, f = 1 MHz T_A = 25°C	—	—	12	pF

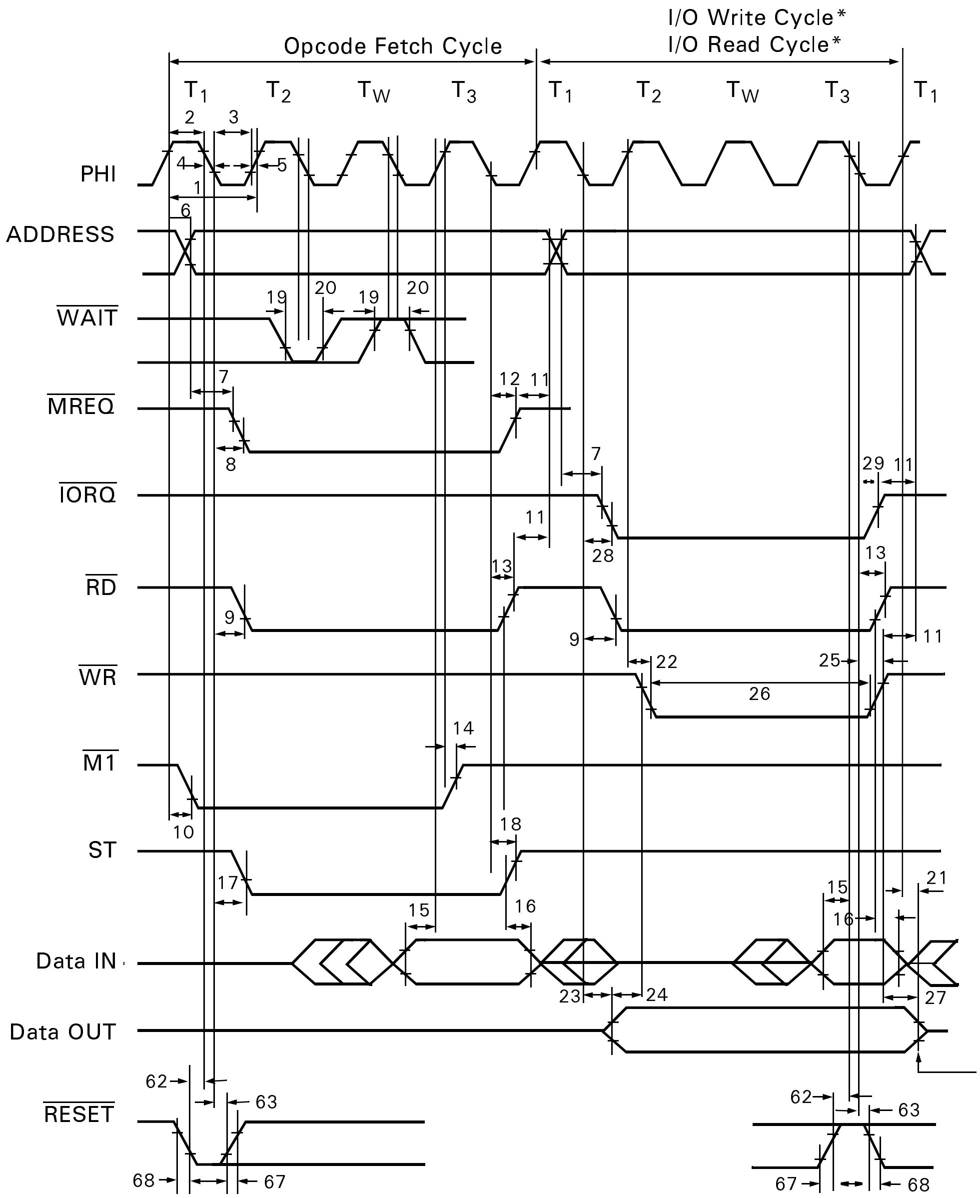
Note:
1. V_{IHmin} = V_{DD}–1.0V, V_{ILmax} = 0.8V (All output terminals are at NO LOAD.) V_{DD} = 5.0V.

Table 7. Z8L180 DC Characteristics
V_{DD} = 3.3V ±10%; V_{SS} = 0V

Symbol	Item	Condition	Min	Typ	Max	Unit
V_{IH1}	Input H Voltage $\overline{RESET}$, EXTAL, $\overline{NMI}$		V_{DD} –0.6		V_{DD} +0.3	V
V_{IH2}	Input H Voltage Except $\overline{RESET}$, EXTAL, $\overline{NMI}$		2.0		V_{DD} +0.3	V
V_{IL1}	Input L Voltage RESET, EXTAL, NMI		–0.3		0.6	V
V_{IL2}	Input L Voltage Except RESET, EXTAL, NMI		–0.3		0.8	V
V_{OH}	Outputs H Voltage All outputs	I_{OH} = –200 µA	2.15			V
		I_{OH} = –20 µA	V_{DD} –0.6			V
V_{OL}	Outputs L Voltage All Outputs	I_{OL} = 4 mA			0.4	V
I_{IL}	Input Leakage Current All Inputs Except XTAL, EXTAL	V_{IN} = 0.5 ~ V_{DD} –0.5			1.0	µA
I_{TL}	Three State Leakage Current	V_{IN} = 0.5 ~ V_{DD} –0.5			1.0	µA
I_{DD1}	Power Dissipation (Normal Operation)	F = 20 MHz		30	60	mA
		4 MHz		4	10	
	Power Dissipation (SYSTEM STOP mode)	F = 20 MHz		5	10	
		4 MHz		2	5	
C_P	Pin Capacitance	V_{IN} = 0V, f = 1 MHz T_A = 25° C			12	pF

Note:
1. V_{IHmin} = V_{DD} –1.0V, V_{ILmax} = 0.6V (All output terminals are at NO LOAD.) V_{DD} = 3.0V.

TIMING DIAGRAMS



Note: *Memory Read/Write Cycle timing is the same as I/O Read/Write Cycle except there are no automatic wait states (T_W), and MREQ is active instead of IORQ.

Figure 20. CPU Timing (Opcode Fetch Cycle, Memory Read Cycle, Memory Write Cycle, I/O Write Cycle, I/O Read Cycle)

TIMING DIAGRAMS (Continued)

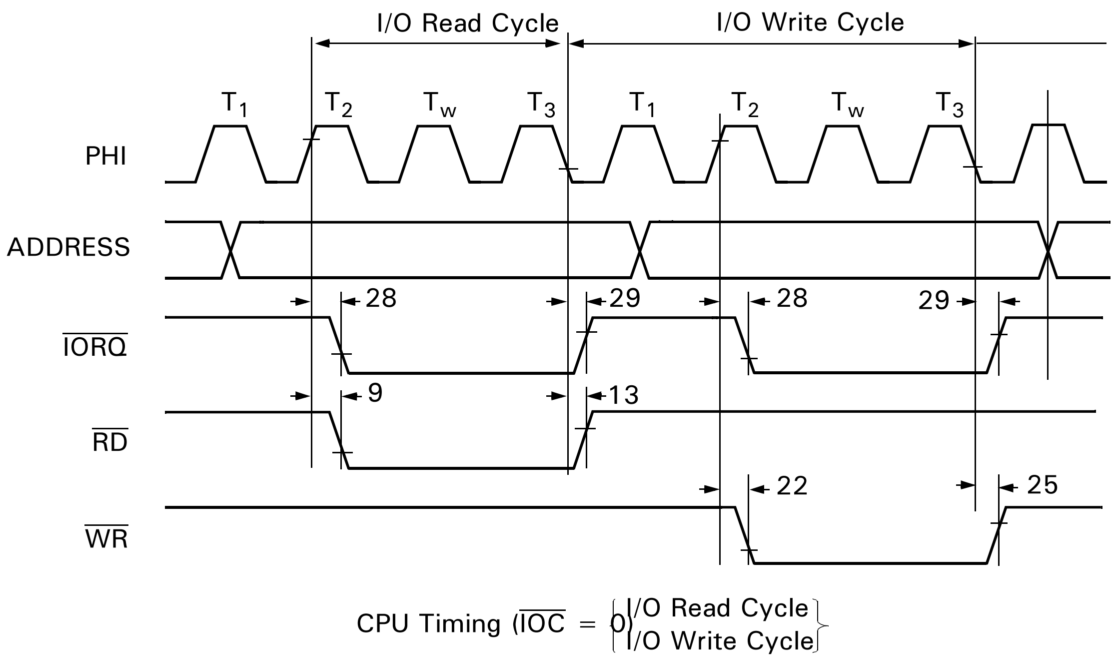
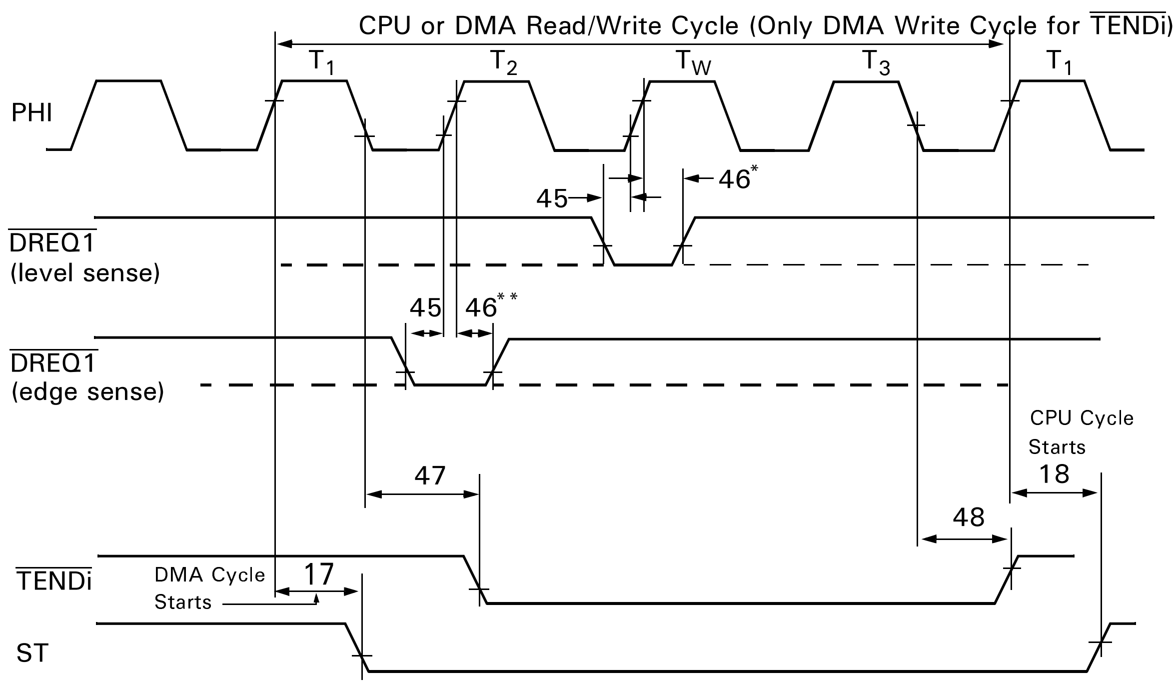


Figure 22. CPU Timing ($\overline{IOC}$ = 0) (I/O Read Cycle, I/O Write Cycle)



Notes:
*T_{DRQS} and T_{DRQH} are specified for the rising edge of the clock followed by T_3.
**T_{DRQS} and T_{DRQH} are specified for the rising edge of the clock.

Figure 23. DMA Control Signals

Data can be written into and read from the ASCI Transmit Data Register. If data is read from the ASCI Transmit Data Register, the ASCI data transmit operation is not affected by this READ operation.

ASCI Receive Shift Register 0,1 (RSR0,1). This register receives data shifted in on the RXA pin. When full, data is automatically transferred to the ASCI Receive Data Register (RDR) if it is empty. If RSR is not empty when the next incoming data byte is shifted in, an overrun error occurs. This register is not program accessible.

ASCI Receive Data FIFO 0,1 (RDR0, 1:I/O Address = 08H, 09H). The ASCI Receive Data Register is a read-only register. When a complete incoming data byte is assembled in RSR, it is automatically transferred to the 4 character Receive Data First-In First-Out (FIFO) memory. The oldest character in the FIFO (if any) can be read from the Receive Data Register (RDR). The next incoming data byte can be shifted into RSR while the FIFO is full. Thus, the ASCI receiver is well buffered.

ASCI STATUS FIFO

This four-entry FIFO contains Parity Error, Framing Error, Rx Overrun, and Break status bits associated with each character in the receive data FIFO. The status of the oldest character (if any) can be read from the ASCI status registers.

ASCI CHANNEL CONTROL REGISTER A

ASCI Control Register A 0 (CNTLA0: I/O Address = 00H)

Bit	7	6	5	4	3	2	1	0
	MPE	RE	TE	$\overline{\text{RTS0}}$	MPBR/ EFR	MOD2	MOD1	MOD0
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

ASCI Control Register A 1 (CNTLA1: I/O Address = 01H)

Bit	7	6	5	4	3	2	1	0
	MPE	RE	TE	CKA1D	MPBR/ EFR	MOD2	MOD1	MOD0
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Figure 33. ASCI Channel Control Register A

MPE: Multi-Processor Mode Enable (Bit 7). The ASCI features a multiprocessor communication mode that utilizes an extra data bit for selective communication when a number of processors share a common serial bus. Multiprocessor data format is selected when the MP bit in CNTLB is set to 1. If multiprocessor mode is not selected (MP bit in CNTLB = 0), MPE has no effect. If multiprocessor mode is selected, MPE enables or disables the *wake-up* feature as follows. If MBE is set to 1, only received bytes in which the multiprocessor bit (MPB) = 1 can affect the RDRF and error flags. Effectively, other bytes (with MPB = 0) are *ignored* by the ASCI. If MPE is reset to 0, all bytes, regardless of the state of the MPB data bit, affect the REDR and error flags. MPE is cleared to 0 during RESET.

RE: Receiver Enable (Bit 6). When RE is set to 1, the ASCI transmitter is enabled. When TE is reset to 0, the transmitter is disables and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the previous contents of TDRE are held. TE is cleared to 0 in IOSTOP mode during RESET.

TE: Transmitter Enable (Bit 5). When TE is set to 1, the ASCI receiver is enabled. When $\overline{\text{TE}}$ is reset to 0, the transmitter is disabled and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the pre-

ASCI CHANNEL CONTROL REGISTER B

ASCI Control Register B 0 (CNTLB0: I/O Address = 02H)
ASCI Control Register B 1 (CNTLB1: I/O Address = 03H)

Bit	7	6	5	4	3	2	1	0
	MPBT	MP	$\overline{\text{CTS}}$/PS	PEO	DR	SS2	SS1	SS0
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Figure 34. ASCI Channel Control Register B

MPBT: Multiprocessor Bit Transmit (Bit 7). When multiprocessor communication format is selected (MP bit = 1), MPBT is used to specify the MPB data bit for transmission. If MPBT = 1, then MPB = 1 is transmitted. If MPBT = 0, then MPB = 0 is transmitted. The MPBT state is undefined during and after RESET.

MP: Multiprocessor Mode (Bit 6). When MP is set to 1, the data format is configured for multiprocessor mode based on MOD2 (number of data bits) and MOD0 (number of stop bits) in CNTLA. The format is as follows:

Start bit + 7 or 8 data bits + MPB bit + 1 or 2 stop bits

Multiprocessor (MP = 1) format offers no provision for parity. If MP = 0, the data format is based on MOD0, MOD1, MOD2, and may include parity. The MP bit is cleared to 0 during RESET.

$\overline{\text{CTS}}$/PS: Clear to Send/Prescale (Bit 5). When read, $\overline{\text{CTS}}$/PS reflects the state of the external $\overline{\text{CTS}}$ input. If the $\overline{\text{CTS}}$ input pin is High, $\overline{\text{CTS}}$/PS is read as 1.

Note: When the $\overline{\text{CTS}}$ input pin is High, the TDRE bit is inhibited (that is, held at 0).

For channel 1, the $\overline{\text{CTS}}$ input is multiplexed with RXS pin (Clocked Serial Receive Data). Thus, $\overline{\text{CTS}}$/PS is only valid when read if the channel 1 CTS1E bit = 1 and the $\overline{\text{CTS}}$ input pin function is selected. The READ data of $\overline{\text{CTS}}$/PS is not affected by $\overline{\text{RESET}}$.

If the SS2–0 bits in this register are not 111, and the BRG mode bit in the ASEXT register is 0, then writing to this bit sets the prescale (PS) control. Under those circumstances, a 0 indicates a divide-by-10 prescale function while a 1 indicates divide-by-30. The bit resets to 0.

PEO: Parity Even Odd (Bit 4) . PEO selects oven or odd parity. PEO does not affect the enabling/disabling of parity (MOD1 bit of CNTLA). If PEO is cleared to 0, even parity is selected. If PEO is set to 1, odd parity is selected. PEO is cleared to 0 during RESET.

DR: Divide Ratio (Bit 3). If the X1 bit in the ASEXT register is 0, this bit specifies the divider used to obtain baud rate from the data sampling clock. If DR is reset to 0, divide-by-16 is used, while if DR is set to 1, divide-by-64 is used. DR is cleared to 0 during RESET.

SS2,1,0: Source/Speed Select 2,1,0 (Bits 2–0). First, if these bits are 111, as they are after a RESET, the CKA pin is used as a clock input, and is divided by 1, 16, or 64 depending on the DR bit and the X1 bit in the ASEXT register.

If these bits are not 111 and the BRG mode bit is ASEXT is 0, then these bits specify a power-of-two divider for the PHI clock as indicated in Table 10.

Setting or leaving these bits as 111 makes sense for a channel only when its CKA pin is selected for the CKA function. CKA0/CKS offers the CKA0 function when bit 4 of the System Configuration Register is 0. $\overline{\text{DCD0}}$/CKA1 offers the CKA1 function when bit 0 of the Interrupt Edge register is 1.

Table 10. Divide Ratio

SS2	SS1	SS0	Divide Ratio
0	0	0	÷1
0	0	1	÷2
0	1	0	÷4
0	1	1	÷8
1	0	0	÷16
1	0	1	÷32
1	1	0	÷64
1	1	1	External Clock

ASCI EXTENSION CONTROL REGISTER CHANNEL 0 AND CHANNEL 1 (Continued)

Timer Data Register Channel 1 Low

Mnemonic TMDR1L
Address 14H

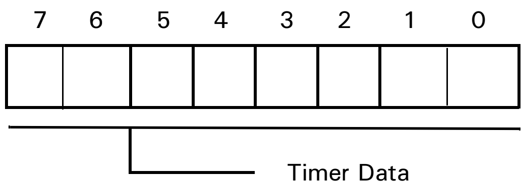


Figure 48. Timer Data Register 1 Low

Timer Data Register Channel 1 High

Mnemonic TMDR1H
Address 15H

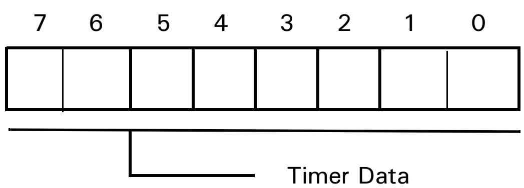


Figure 49. Timer Data Register 1 High

Timer Reload Register Channel 1 Low

Mnemonic RLDR1L
Address 16

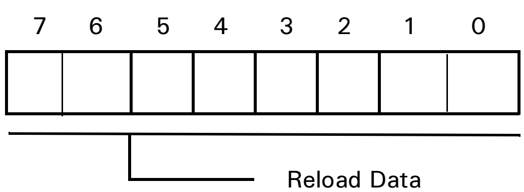


Figure 50. Timer Reload Channel 1 Low

Timer Reload Register Channel 1 High

Mnemonic RLDR1H
Address 17H

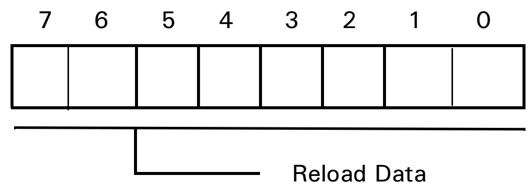


Figure 51. Timer Reload Register Channel 1 High

Free Running Counter (Read Only)

Mnemonic FRC
Address 18H

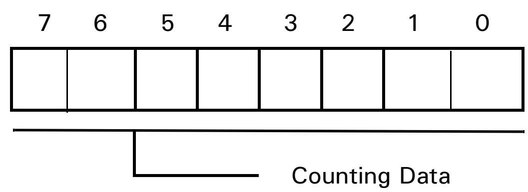


Figure 52. Free Running Counter

CLOCK MULTIPLIER REGISTER

(Z180 MPU Address 1EH)

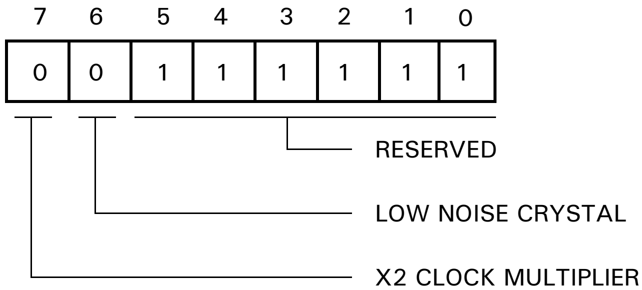


Figure 54. Clock Multiplier Register

Bit 7. X2 Clock Multiplier Mode. When this bit is set to 1, the programmer can double the internal clock speed from the speed of the external clock. This feature only operates effectively with frequencies of 10–16 MHz (20–32 MHz internal). When this bit is set to 0, the Z8S180/Z8L180 device operates in normal mode. At power-up, this feature is disabled.

Bit 6. Low Noise Crystal Option. Setting this bit to 1 enables the low-noise option for the EXTAL and XTAL pins. This option reduces the gain in addition to reducing the output drive capability to 30% of its original drive capability. The Low Noise Crystal Option is recommended in the use of crystals for PCMCIA applications, where the crystal may be driven too hard by the oscillator. Setting this bit to 0 is selected for normal operation of the EXTAL and XTAL pins. The default for this bit is 0.

Note: Operating restrictions for device operation are listed below. If a low-noise option is required, and normal device operation is required, use the clock multiplier feature.

Table 13. Low Noise Option

Low Noise ADDR 1E, bit 6 = 1	Normal ADDR 1E, bit 6 = 0
20 MHz @ 4.5V, 100°C	33 MHz @ 4.5V, 100°C
10 MHz @ 3.0V, 100°C	20 MHz @ 3.0V, 100°C

DMA DESTINATION ADDRESS REGISTER CHANNEL 0

The DMA Destination Address Register Channel 0 specifies the physical destination address for channel 0 transfers. The register contains 20 bits and can specify up to 1024-KB memory addresses or up to 64-KB I/O addresses. Channel 0 destination can be memory, I/O, or memory mapped I/O. For I/O, the MS bits of this register identify the Request Handshake signal for channel 0.

DMA Destination Address Register Channel 0 Low

Mnemonic DAR0L
Address 23H

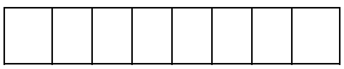


Figure 58. DMA Destination Address Register Channel 0 Low

DMA Destination Address Register Channel 0 High

Mnemonic DAR0H
Address 24H

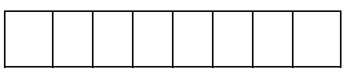


Figure 59. DMA Destination Address Register Channel 0 High

DMA Destination Address Register Channel 0B

Mnemonic DAR0B
Address 25H

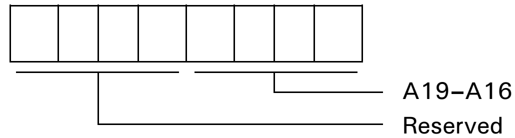


Figure 60. DMA Destination Address Register Channel 0B

If the DMA destination is in I/O space, bits 1–0 of this register select the DMA request signal for DMA0, as follows:

Bit 1 (A17)	Bit 0 (A16)	DMA Transfer Request
0	0	DREQ0 (external)
0	1	TDR0 (ASCI0)
1	0	TDR1 (ASCI1)
1	1	Not Used

DMA MEMORY ADDRESS REGISTER CHANNEL 1

The DMA Memory Address Register Channel 1 specifies the physical memory address for channel 1 transfers. The address may be a destination or a source memory location. The register contains 20 bits and may specify up to 1024 KB memory addresses.

DMA Memory Address Register, Channel 1L

Mnemonic MAR1L
Address 28H

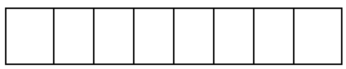


Figure 65. DMA Memory Address Register, Channel 1L

DMA Memory Address Register, Channel 1H

Mnemonic MAR1H
Address 29H

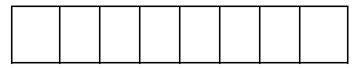


Figure 66. DMA Memory Address Register, Channel 1H

DMA Memory Address Register, Channel 1B

Mnemonic MAR1B
Address 2AH

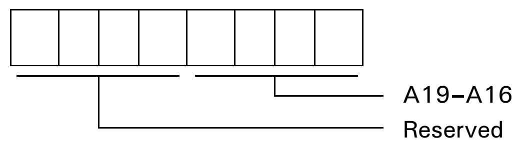


Figure 67. DMA Memory Address Register, Channel 1B

DMA STATUS REGISTER

The DMA Status Register (DSTAT) is used to enable and disable DMA transfer and DMA termination interrupts. DSTAT also indicates DMA transfer status, Completed or In Progress.

DMA Status Register

Mnemonic DSTAT
Address 30H

Bit	7	6	5	4	3	2	1	0
	DE1	DE0	$\overline{\text{DWE1}}$	$\overline{\text{DWE0}}$	DIE1	DIE0	—	DME
	R/W	R/W	W	W	R/W	R/W		R

Figure 71. DMA Status Register (DSTAT: I/O Address = 30H)

DE1: DMA Enable Channel 1 (Bit 7). When DE1 = 1 and DME = 1, channel 1 DMA is enabled. When a DMA transfer terminates (BCR1 = 0), DE1 is reset to 0 by the DMAC. When DE1 = 0 and the DMA interrupt is enabled (DIE1 = 1), a DMA interrupt request is made to the CPU.

To perform a software WRITE to DE1, $\overline{\text{DWE1}}$ should be written with a 0 during the same register WRITE access. Writing DE1 to 0 disables channel 1 DMA, but DMA is restartable. Writing DE1 to 1 enables channel 1 DMA and automatically sets DMA Main Enable (DME) to 1. DE1 is cleared to 0 during RESET.

DE0: DMA Enable Channel 0 (Bit 6). When DE0 = 1 and DME = 1, channel 0 DMA is enabled. When a DMA transfer terminates (BCR0 = 0), DE0 is reset to 0 by the DMAC. When DE0 = 0 and the DMA interrupt is enabled (DIE0 = 1), a DMA interrupt request is made to the CPU.

To perform a software WRITE to DE0, $\overline{\text{DWE0}}$ should be written with 0 during the same register WRITE access. Writing DE0 to 0 disables channel 0 DMA. Writing DE0 to 1 enables channel 0 DMA and automatically sets DMA Main Enable (DME) to 1. DE0 is cleared to 0 during RESET.

$\overline{\text{DWE1}}$: DE1 Bit Write Enable (Bit 5). When performing any software WRITE to DE1, this bit should be written with 0 during the same access. $\overline{\text{DWE1}}$ always reads as 1.

$\overline{\text{DWE0}}$: DE0 Bit Write Enable (Bit 4). When performing any software WRITE to DE0, this bit should be written with 0 during the same access. $\overline{\text{DWE0}}$ always reads as 1.

DIE1: DMA Interrupt Enable Channel 1 (Bit 3). When DIE0 is set to 1, the termination channel 1 DMA transfer (indicated when DE1 = 0) causes a CPU interrupt request to be generated. When DIE0 = 0, the channel 0 DMA termination interrupt is disabled. DIE0 is cleared to 0 during RESET.

DIE0: DMA Interrupt Enable Channel 0 (Bit 2). When DIE0 is set to 1, the termination channel 0 of DMA transfer (indicated when DE0 = 0) causes a CPU interrupt request to be generated. When DIE0 = 0, the channel 0 DMA termination interrupt is disabled. DIE0 is cleared to 0 during RESET.

DME: DMA Main Enable (Bit 0). A DMA operation is only enabled when its DE bit (DE0 for channel 0, DE1 for channel 1) and the DME bit is set to 1.

When $\overline{\text{NMI}}$ occurs, DME is reset to 0, thus disabling DMA activity during the $\overline{\text{NMI}}$ interrupt service routine. To restart DMA, DE– and/or DE1 should be written with a 1 (even if the contents are already 1). This condition automatically sets DME to 1, allowing DMA operations to continue.

Note: DME cannot be directly written. The bit is cleared to 0 by $\overline{\text{NMI}}$ or indirectly set to 1 by setting DE0 and/or DE1 to 1. DME is cleared to 0 during RESET.

DMA MODE REGISTER

The DMA Mode Register (DMODE) is used to set the addressing and transfer mode for channel 0.

DMA Mode Register

Mnemonic DMODE
Address 31H

Bit	7	6	5	4	3	2	1	0
	—	—	DM1	DM0	SM1	SM0	MMOD	—
			R/W	R/W	R/W	R/W	R/W	

Figure 72. DMA Mode Register (DMODE: I/O Address = 31H)

DM1, DM0: Destination Mode Channel 0 (Bits 5,4). This mode specifies whether the destination for channel 0 transfers is memory or I/O, and whether the address should be incremented or decremented for each byte transferred. DM1 and DM0 are cleared to 0 during RESET.

Table 14. Channel 0 Destination

DM1	DM0	Memory I/O	Memory Increment/Decrement
0	0	Memory	+1
0	1	Memory	–1
1	0	Memory	fixed
1	1	I/O	fixed

SM1, SM0: Source Mode Channel 0 (Bits 3, 2) . This mode specifies whether the source for channel 0 transfers is memory or I/O, and whether the address should be incremented or decremented for each byte transferred.

Table 15. Channel 0 Source

SM1	SM0	Memory I/O	Memory Increment/Decrement
0	0	Memory	+1
0	1	Memory	–1
1	0	Memory	fixed
1	1	I/O	fixed

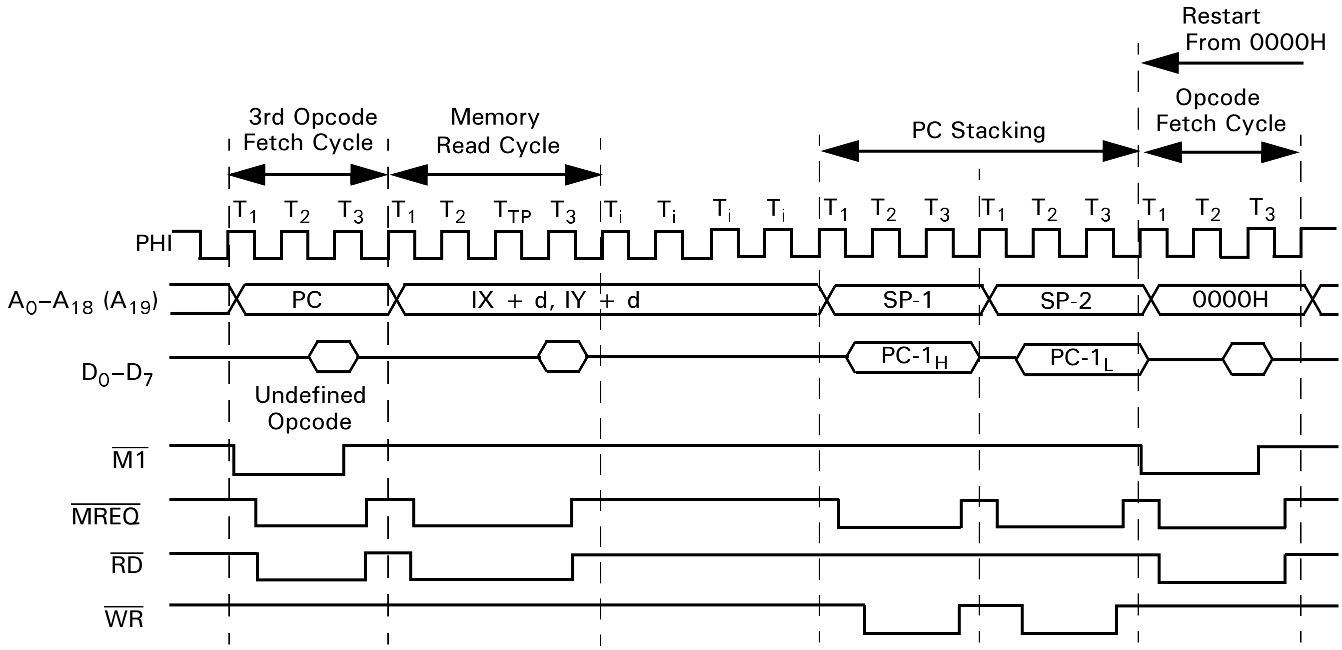
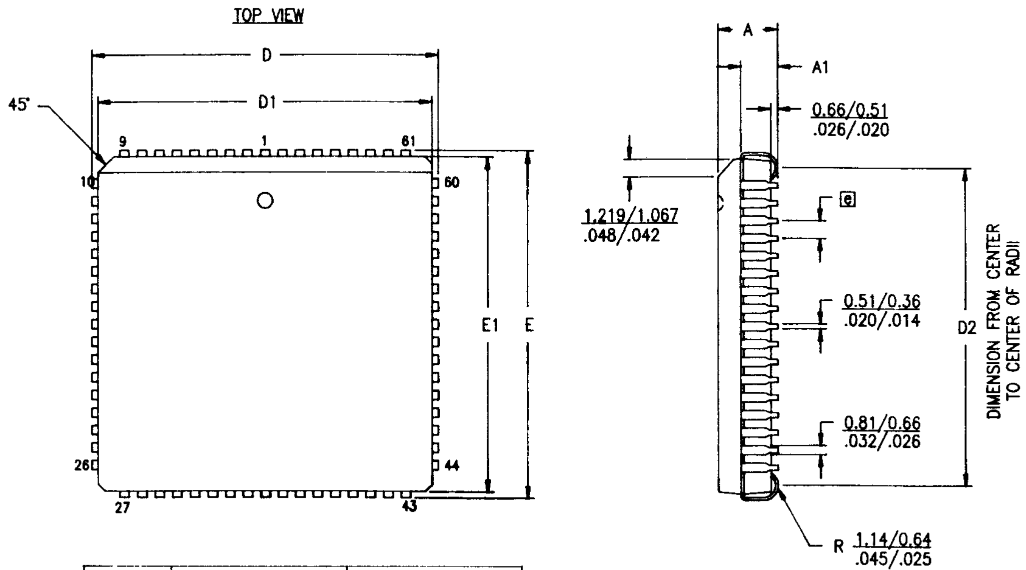


Figure 76. TRAP Timing—3rd Opcode Undefined



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	4.32	4.57	.170	.180
A1	2.43	2.92	.095	.115
D/E	25.02	25.40	.985	1.000
D1/E1	24.13	24.33	.950	.958
D2	22.86	23.62	.900	.930
e	1.27 TYP		.050 TYP	

NOTES:

1. CONTROLLING DIMENSIONS : INCH
2. LEADS ARE COPLANAR WITHIN .004 IN RANGE.
3. DIMENSION : MM / INCH

Figure 87. 68-Pin PLCC Package Diagram

ORDERING INFORMATION

Codes	
Speed	10 = 10 MHz 20 = 20 MHz 33 = 33 MHz
Package	P = 60-Pin Plastic DIP V = 68-Pin PLCC F = 80-Pin QFP
Temperature	S = 0°C to +70°C E = –40°C to +85°C
Environmental	C = Plastic Standard

For fast results, contact your local ZiLOG sales office for assistance in ordering the part(s) required.

Example:

Z 8S180 10 P S C is a Z8S180 10-MHz 60-Pin DIP, 0° to +70°C, Plastic Standard Flow

- C — Environmental Flow
- S — Temperature
- P — Package
- 10 — Speed
- 8S180 — Product Number
- Z — ZiLOG Prefix

Pre-Characterization Product

The product represented by this document is newly introduced and ZiLOG has not completed the full characterization of the product. The document states what ZiLOG knows about this product at this time, but additional features or non-conformance with some aspects of the document may be found, either by ZiLOG or its customers in the course of further application and characterization work. In addition, ZiLOG cautions that delivery may be uncertain at times, due to start-up yield issues.

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